



## PNP SILICON POWER TRANSISTOR

#### **DESCRIPTION**

These 2N6317 and 2N6318 devices are an excellent choice for un-tuned amplifier applications. It is also ideal for general purpose power switch and amplifier applications. Microsemi also offers numerous other products to meet higher and lower power voltage regulation applications.



TO-213AA (TO-66) Package

Important: For the latest information, visit our website <a href="http://www.microsemi.com">http://www.microsemi.com</a>.

#### **FEATURES**

- Hermetically sealed.
- Complimentary pairing with the NPN 2N6315 and 2N6316.
- RoHS compliant versions available.

## **APPLICATIONS / BENEFITS**

- · Convenient package.
- Mechanically rugged.
- · Commercial, industrial, and military uses.

#### MAXIMUM RATINGS @ 25 °C unless otherwise stated

Parameters/Test Conditions		Symbol	Value	Unit
Junction and Storage Temperature		$T_J$ and $T_{STG}$	-65 to +200	°C
Thermal Resistance Junction-to-Lead (1)		$R_{\Theta JL}$	235	°C
Collector-Base Voltage	2N6317	$V_{CBO}$	60	V
	2N6318		80	
Emitter-Base Voltage		$V_{EBO}$	5	V
Collector-Emitter Voltage	2N6317	$V_{CEO}$	60	V
	2N6318		80	
Continuous Operating Collector Current		Ic	7	Α
Continuous Base Current			2	Α
Total Power Dissipation (2)		P <sub>T</sub>	90	W

NOTES: 1. At 1/8 inch from case for 10 seconds.

2. Derate linearly at 0.515 W/°C.

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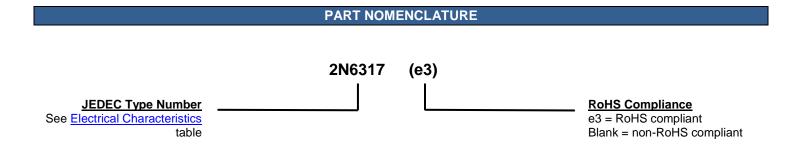
#### Website:

www.microsemi.com



## **MECHANICAL and PACKAGING**

- CASE: Hermetic, TO-66 package. Nickel plate with nickel cap.
- TERMINALS: Solder dipped (Sn63/Pb37) over nickel plated alloy 52. RoHS compliant matte-tin plating is also available.
- MARKING: MSC, part number, date code, polarity symbol.
- WEIGHT: Approximately 5.7 grams.
- See Package Dimensions on last page.



	SYMBOLS & DEFINITIONS			
Symbol	Symbol Definition			
I <sub>B</sub>	Base current			
T <sub>C</sub>	Case temperature			
$V_{CB}$	Collector-base voltage			
V <sub>CC</sub>	Collector-supply voltage			
$V_{EB}$	Emitter-base voltage			



# ELECTRICAL CHARACTERISTICS @ 25 °C unless otherwise stated

Parameters / Test Conditions	Symbol	Min.	Max.	Unit	
STATIC CHARACTERISTICS					
Collector Cutoff Current $V_{CE} = 60 V_{BE} = 1.5 V$ , $T_{C} = 150 °C$ $V_{CE} = 80 V_{BE} = 1.5 V$ , $T_{C} = 150 °C$	2N6317 2N6318	I <sub>CEX</sub>		2.0	mA
Collector Cutoff Current $V_{CE} = 60 V_{BE} = 1.5 V$ $V_{CE} = 80 V_{BE} = 1.5 V$	2N6317 2N6318	I <sub>CEX</sub>		0.25	mA
Emitter Cutoff Current V <sub>EB</sub> = 5 V		I <sub>EBO</sub>		1.0	mA
Collector-Emitter Open Base Sustain Voltage $^{(1)}$ $I_B = 0$ , $I_C = 100$ mA	2N6317 2N6318	V <sub>CEO(sus)</sub>	60 80		
Collector Cutoff Current, Base Open $I_B = 0$ , $V_{CE} = 30 \text{ V}$ $I_B = 0$ , $V_{CE} = 40 \text{ V}$	2N6317 2N6318	I <sub>CEO</sub>		0.5	mA
DC Forward Current Transfer Ratio $^{(1)}$ $I_C = 7$ A, $V_{CE} = 4$ V $I_C = 2.5$ A, $V_{CE} = 4$ V $I_C = 0.5$ A, $V_{CE} = 4$ V		h <sub>FE</sub>	4 25 35	125	
Collector-Emitter Saturation Voltage $^{(1)}$ $I_C = 7.0 \text{ A}, I_B = 1.75 \text{ A}$ $I_C = 4.0 \text{ A}, I_B = 0.4 \text{ A}$		V <sub>CE(sat)</sub>		2.0 1.0	V
Base-Emitter Saturation Voltage $^{(1)}$ $I_C = 7.0 \text{ A}, I_B = 1.75 \text{ A}$		V <sub>BE(sat)</sub>		2.5	V
Base-Emitter Voltage $^{(1)}$ $I_C = 2.5 \text{ A}, V_{CE} = 4.0 \text{ V}$		$V_{BE}$		1.5	V

**NOTE:** 1. Pulse Width  $\leq$  300  $\mu$ s; duty cycle  $\leq$  2 %.

## **DYNAMIC CHARACTERISTICS**

Parameters / Test Conditions	Symbol	Min.	Max.	Unit
Magnitude of Common Emitter Small-Signal Short-Circuit Forward Current Transfer Ratio $V_{CE} = 10 \text{ V}, I_{C} = 0.25 \text{ A}, f = 1 \text{ MHz}$	h <sub>fe</sub>	4		
Common Base Output $V_{CB} = 10 \text{ V}, I_E = 0 \text{ A}, f = 1 \text{ MHz}$	C <sub>ob</sub>		300	pF
Common Emitter Small-Signal Short-Circuit Forward Current Trans-Ratio V <sub>CE</sub> = 4 V, I <sub>C</sub> = 0.5 A, f = 1 kHz	h <sub>fe</sub>	20		

# **SWITCHING CHARACTERISTICS**

Parameters / Test Conditions	Symbol	Min.	Max.	Unit
Rise time $V_{CC} = 30 \text{ V}, I_C = 25 \text{ A}, I_{B1} = I_{B2} = 0.25 \text{ A} \text{ (see figure 2)}$	t <sub>r</sub>		0.7	μS
Storage time $V_{CC} = 30 \text{ V}, I_C = 25 \text{ A}, I_{B1} = I_{B2} = 0.25 \text{ A} \text{ (see figure 2)}$	t <sub>s</sub>		1.0	μS
Fall time $V_{CC} = 30 \text{ V}$ , $I_C = 25 \text{ A}$ , $I_{B1} = I_{B2} = 0.25 \text{ A}$ (see figure 2)	t <sub>f</sub>		0.8	μS



## **GRAPHS**

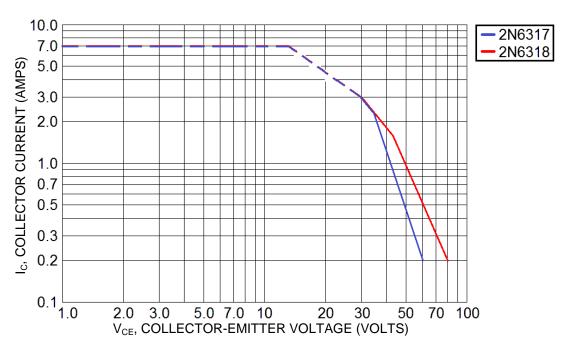
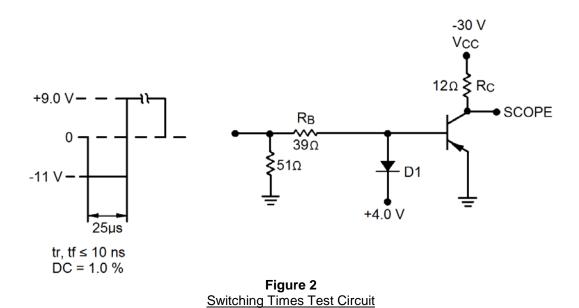
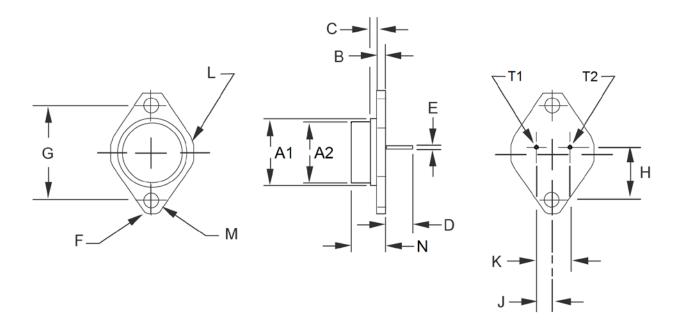


Figure 1
Safe Operating Area (T<sub>C</sub> = 25 °C)





# PACKAGE DIMENSIONS



DIM	INCH		MILLIMETERS			
	MIN	MAX	MIN	MAX		
A1	.470	.500	11.94	12.70		
A2	-	.620	-	15.75		
В	.050	.075	1.27	1.91		
С	-	.050	-	1.27		
D	.360	1	9.14	-		
E	.028	.034	0.71	0.86		
F	.145	radius	3.68 radius			
G	.958	.962	24.33	24.43		
Н	.570	.590	14.48	14.99		
J	.093	.107	2.36	2.72		
K	.190	.210	4.83	5.33		
L	.350	.350 radius		8.89 radius		
М	.142	.152	3.61	3.86		
N	.250	.340	6.35	8.64		
T1	Base					
T2	Emitter					
Case	Collector					

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